

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Opening RICHMOND 8300 ESD SHIELDING BAG METAL OUT CONSTRUCTION Length (L) DEVICES. HANDLE ONLY AT ESD PROTECTED AREAS MADE IN AMERICA Weld Width (W Seal

Side Weld Seals 3/8 in.

Item No.	Size (in.) W x L	Item No.	Size (in.) W x L
48500	4 x 4	48509	10 x 14
48501	4 x 6	48510	11 x 15
48502	5 x 8	48511	12 x 16
48503	6 x 8	48512	12 x 18
48504	6 x 10	48513	14 x 16
48505	8 x 8	48514	14 x 18
48506	8 x 10	48515	14 x 24
48507	8 x 12	48516	18 x 24
48508	10 x 12		
Packaged 100 per package			

RICHMOND 8300 SERIES

Specifications:

Electrical Properties Test Procedures/Method Typical Values

Surface Resistance:

 $<10^{11}$ ohms Outer Surface ANSI/ESD S11.11 $<10^2$ ohms Aluminum Layer ANSI/ESD S11.11 $<10^{11}$ ohms Inner Surface ANSI/ESD S11.11 Static Shielding <20 nJ ANSI/ESD S11.31 Charge Generation (nC/in²) Teflon: -0.03 Modified Incline Plane Quartz: +0.10 Modified Incline Plane

Capacitance Probe (to dissipate 1 KV) <30V ANSI/EIA 541/Appendix E, 1kV Discharge

Physical Properties:

Bag Thickness: Polyester Layer 0.5 Mils Static Dissipative PET film ASTM D-2103

Aluminum Layer 10-25 Angstroms

2.5 Mils Static Dissipative PE film ASTM D-2103 Polyethylene Laver **Total Thickness** 3.0 to 3.1 Mils ASTM D-2103 Light Transmission (%) 40% (Tobias) **ASTM D-1003** Seam Strength Pass ANSI/ESD S541 Tear Strength (lbs) >25 ASTM D-1004 Puncture Resistance (lbs) >10 **ASTM D-2065** MVTR (ams / 100 in² / 24 hrs. 100°F) **ASTM F-1249** 0.40 Burst Strength (psi) >50 psi FTMS 101C, 2065.1 >10 lbs/in. Heat Seal 375°F, 1/2 sec 60 psi

Abrasion Resistance >30 cycles Sutherland Abr. (.0000 Steel Wool)

Pass ASTM E595 Outgassing

Non-corrosive Pass MIL-STD-3010, M3005

Chemical Properties

Polycarbonate Capability,

Corrosion No effect on aluminum, copper, silver, Sn-Pb coated foil,

stainless steel. low carbon steel

Yes

No Amines N-Octanoic Acid Not present

High Performance Static Dissipative Abrasion Resistant Coating

Mixed Unsortable Plastic Scrap Aluminum Shielding Layer Mixed unsortable plastic scrap shall contain assorted plastics

of multiple grades that are co-extruded, bonded or laminated together which are unsortable into individual grades. Static Dissipative Inner Polyethylene Layer

Protektive Pak's bags are recyclable

A fundamental ESD control principle (see ANSI/ESD S20.20 Foreword): ESD susceptible items should be transported and stored outside an Electrostatic protected Area enclosed in low charging, static shielding protective packaging.

The bag's material meets the performance specification requirements of ANSI/ESD S541. Bag is free of amines, N-octanoic acid, and heavy metals.



United States of America

RICHMOND 8300, TRANSPARENT STATIC SHIELDING BAG (METAL OUT)



PROTEKTIVE PAK

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DRAWING NUMBER 48500

Polyester Layer

DATE: December 2012